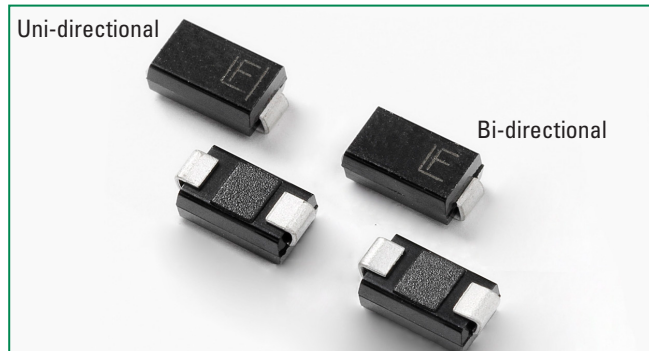


SMAJ-HRA Series

Surface Mount - 400W



Agency Approvals

Agency	Agency File/Certificate Number
	E230531

Maximum Ratings & Thermal Characteristics

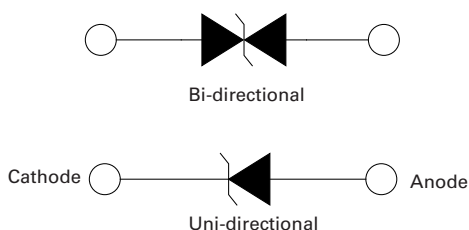
($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation ($I_{PP} \times V_C$) by 10/1000 μs Waveform (Fig.2) (Note 1), (Note 2)	P_{PPM}	400	W
Power Dissipation on Infinite Heat Sink at $T_J = 50^\circ\text{C}$	P_D	3.3	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave (Note 3)	I_{FSM}	60	A
Maximum Instantaneous Forward Voltage at 25A for Unidirectional Only	V_F	3.5	V
Operating Temperature Range	T_J	-65 to 150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to 175	$^\circ\text{C}$
Typical Thermal Resistance Junction to Lead	$R_{\theta JL}$	30	$^\circ\text{C/W}$
Typical Thermal Resistance Junction to Ambient	$R_{\theta JA}$	120	$^\circ\text{C/W}$

Notes:

1. Non-repetitive current pulse, per Fig. 4 and derated above T_J (initial) $= 25^\circ\text{C}$ per Fig. 3.
2. Mounted on copper pad area of 0.31x0.31" (8.0 x 8.0mm) to each terminal.
3. Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional component only

Functional Diagram



Description

The SMAJ-HRA High Reliability series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- Excellent clamping capability
- Typical $I_R \leq 1\mu\text{A}$ for $V_R > 10\text{V}$
- For surface mounted applications to optimize board space
- Low profile package
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- ESD protection of data lines in accordance with IEC 61000-4-2, 30kV(Air), 30kV (Contact)
- EFT protection of data lines in accordance with IEC 61000-4-4
- Built-in strain relief
- 400W Peak pulse power capability at 10/1000 μs waveform, repetition rate (duty cycle): 0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to $V_{BR \min}$
- Glass passivated junction
- Low inductance
- High temperature to reflow soldering guaranteed: $260^\circ\text{C}/40\text{sec}$
- $V_{BR} @ T_J = V_{BR} @ 25^\circ\text{C} \times (1 + \alpha T_J - 25)$ (α : Temperature Coefficient, typical value is 0.1%) Coefficient, typical value
- UL Recognized epoxy meeting flammability rating V-0
- Meet MSL level1, per J-STD-020, LF maximum peak of 260°C
- Matte tin lead-free Plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin(Sn) (IPC/JEDEC J-STD-609A.01)

Applications

TVS Components are ideal for the protection of I/O Interfaces, V_{CC} bus and other vulnerable circuits used in Telecom, Computer, Industrial and Consumer electronic applications.

SMAJ-HRA Series

Surface Mount - 400W

Electrical Characteristics

Part Number (Uni)	Part Number (Bi)	Marking		Reverse Stand off Voltage V_R (Volts)	Breakdown Voltage V_{BR} (Volts) @ I_T		Test Current I_T (mA)	Maximum Clamping Voltage V_C @ I_{PP} (V)	Maximum Peak Pulse Current I_{PP} (A)	Maximum Reverse Leakage I_R @ V_R (μA)	Agency Approval 
		UNI	BI		MIN	MAX					
SMAJ6.0A-HRA	SMAJ6.0CA-HRA	AGH	WGH	6.0	6.67	7.37	10	10.3	38.8	800	X
SMAJ9.0A-HRA	SMAJ9.0CA-HRA	AVH	WVH	9.0	10.00	11.10	1	15.4	26.0	10	X
SMAJ10A-HRA	SMAJ10CA-HRA	AXH	WXH	10.0	11.10	12.30	1	17.0	23.5	5	X
SMAJ11A-HRA	SMAJ11CA-HRA	AZH	WZH	11.0	12.20	13.50	1	18.2	22.0	1	X
SMAJ12A-HRA	SMAJ12CA-HRA	BEH	XEH	12.0	13.30	14.70	1	19.9	20.1	1	X
SMAJ13A-HRA	SMAJ13CA-HRA	BGH	XGH	13.0	14.40	15.90	1	21.5	18.6	1	X
SMAJ14A-HRA	SMAJ14CA-HRA	BKH	XKH	14.0	15.60	17.20	1	23.2	17.2	1	X
SMAJ15A-HRA	SMAJ15CA-HRA	BMH	XMH	15.0	16.70	18.50	1	24.4	16.4	1	X
SMAJ16A-HRA	SMAJ16CA-HRA	BPH	XPH	16.0	17.80	19.70	1	26.0	15.4	1	X
SMAJ17A-HRA	SMAJ17CA-HRA	BRH	XRH	17.0	18.90	20.90	1	27.6	14.5	1	X
SMAJ18A-HRA	SMAJ18CA-HRA	BTH	XTH	18.0	20.00	22.10	1	29.2	13.7	1	X
SMAJ20A-HRA	SMAJ20CA-HRA	BVH	XVH	20.0	22.20	24.50	1	32.4	12.3	1	X
SMAJ26A-HRA	SMAJ26CA-HRA	CEH	YEH	26.0	28.90	31.90	1	42.1	9.5	1	X
SMAJ33A-HRA	SMAJ33CA-HRA	CMH	YMH	33.0	36.70	40.60	1	53.3	7.5	1	X
SMAJ36A-HRA	SMAJ36CA-HRA	CPH	YPH	36.0	40.00	44.20	1	58.1	6.9	1	X
SMAJ45A-HRA	SMAJ45CA-HRA	CVH	YVH	45.0	50.00	55.30	1	72.7	5.5	1	X

Note:

1. For bidirectional type having V_R of 10 volts and less, the I_R limit is double.

SMAJ-HRA Series

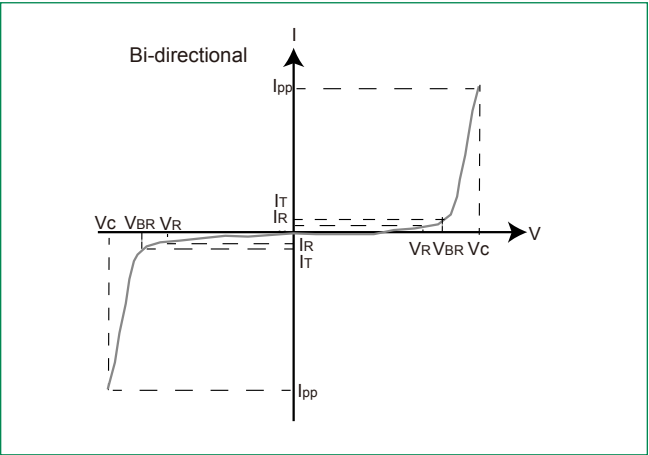
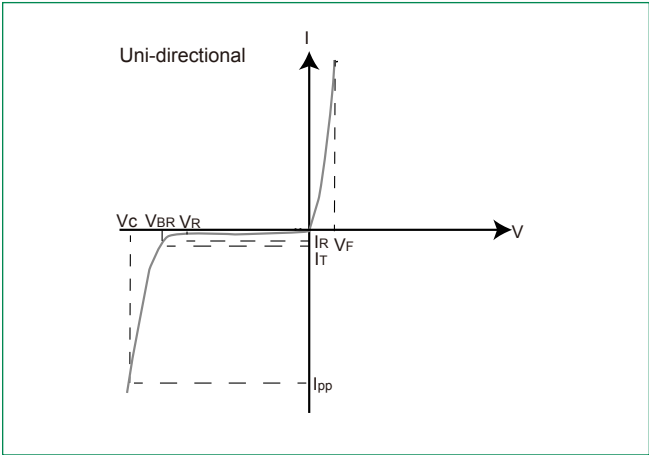
Surface Mount - 400W

Screen Process

100% Vision Inspection	MIL-STD-750 method 2074
100% High Temperature Storage Life (168hrs,175°C)	MIL-STD-750 method 1031
100% X-RAY inspection	MIL-STD-750 method 2076
100% Temperature Cycle Test (-55 to 150°C, 20 cycles, dwell time 15 min)	MIL-STD-750 method 1051
100% Reflow (2X)	JEDEC J-STD-020
100% Surge Test (2x)	MIL-STD-750 method 4066
100% HTRB 150°C Bias= V_R (80% breakdown voltage, 96hrs, and each direction 96hrs for Bi-directional products)	MIL-STD-750 method 1038
Final Electrical Test (100% 3 sigma limit, 100% dynamic test and PAT limit)	MIL-STD-750 method 4016.4021.4011

Note: Up-screen program can be specified by customer's request by contacting Littelfuse customer service

I-V Curve Characteristics



- P_{PPM}** Peak Pulse Power Dissipation -- ($I_{PP} \times V_C$) Max power dissipation
 V_R Stand-off Voltage -- Maximum voltage that can be applied to the TVS without operation
 V_{BR} Breakdown Voltage -- Maximum voltage that flows though the TVS at a specified test current (I_T)
 V_C Clamping Voltage -- Peak voltage measured across the TVS at a specified I_{PPM} (peak impulse current)
 I_R Reverse Leakage Current -- Current measured at V_R
 V_F Forward Voltage Drop for Uni-directional

SMAJ-HRA Series

Surface Mount - 400W

Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform

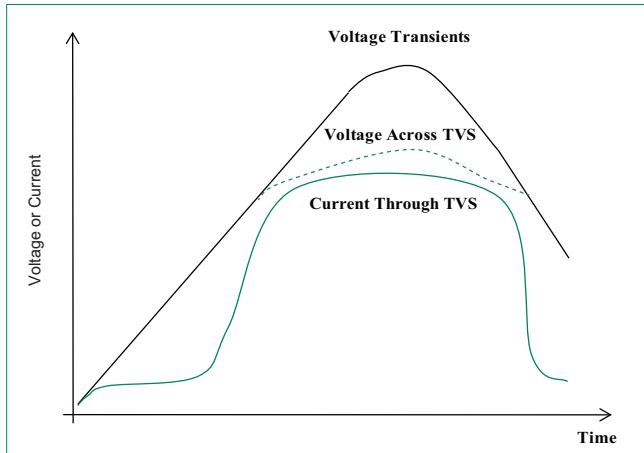


Figure 2 - P_{PPM} Peak Pulse Power Rating Curve

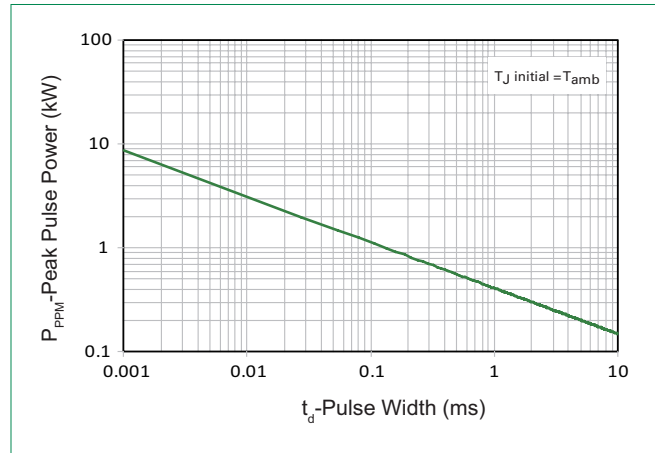


Figure 3 - Peak Pulse Power Derating Curve

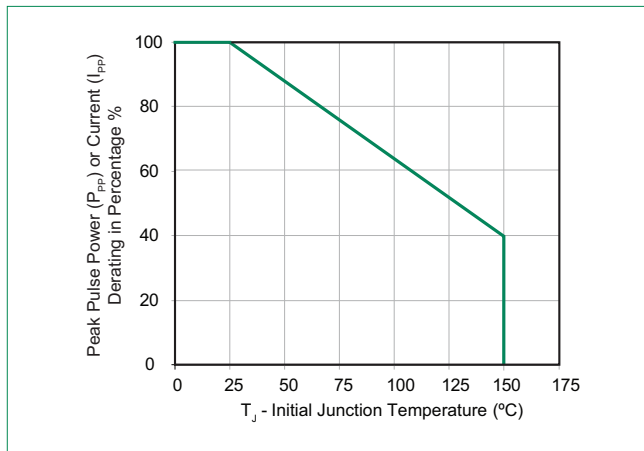


Figure 4 - Pulse Waveform

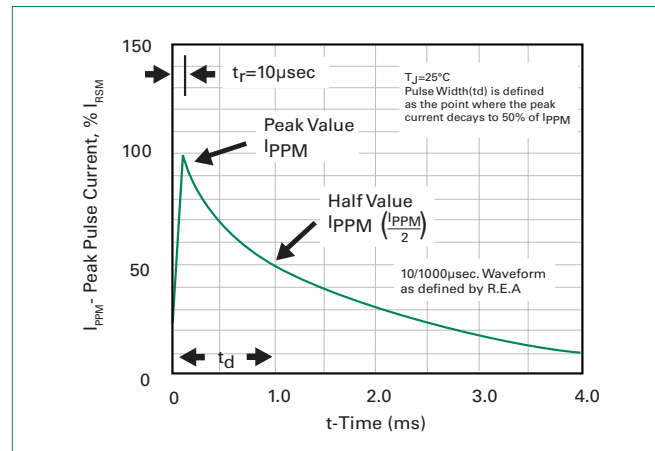


Figure 5 - Typical Junction Capacitance

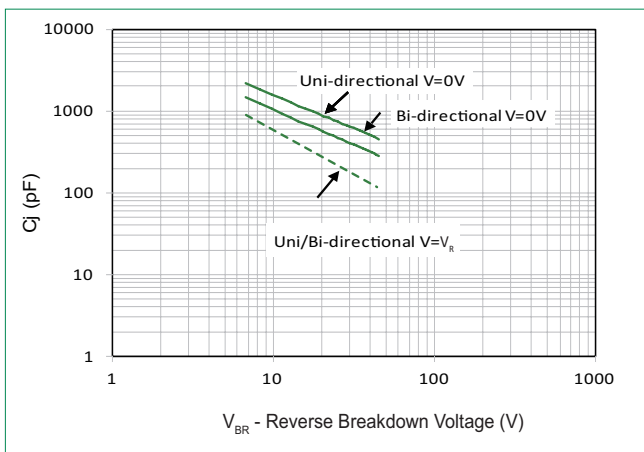
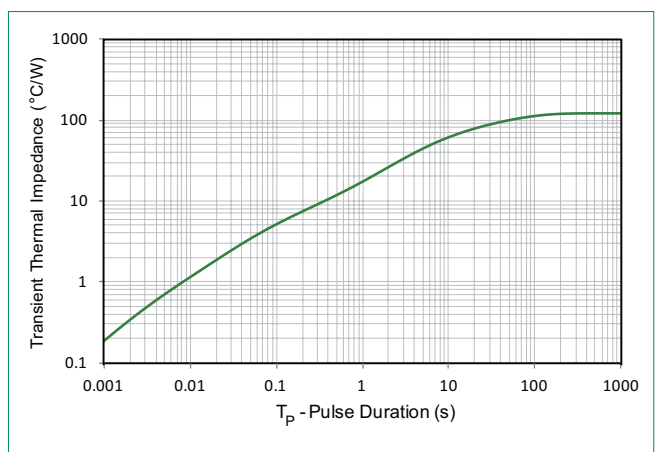


Figure 6 - Typical Transient Thermal Impedance



SMAJ-HRA Series

Surface Mount - 400W

Figure 7 - Maximum Non-Repetitive Forward Surge Current Uni-Directional Only

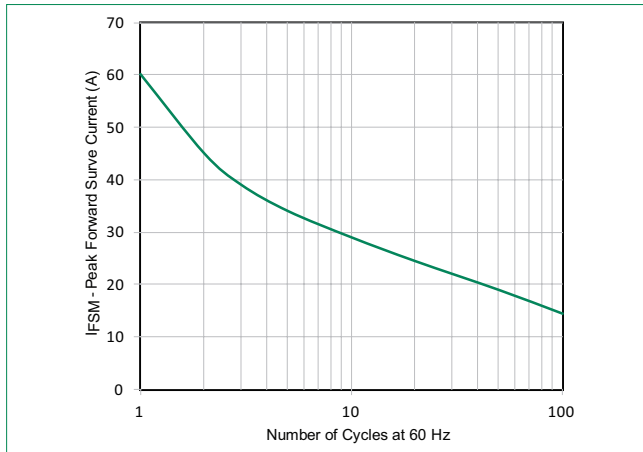
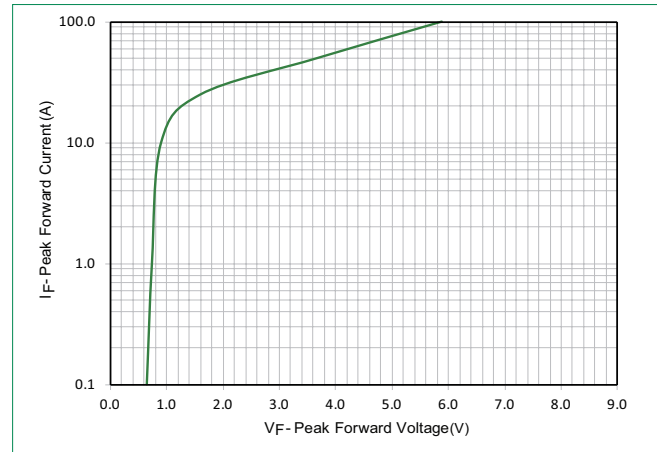
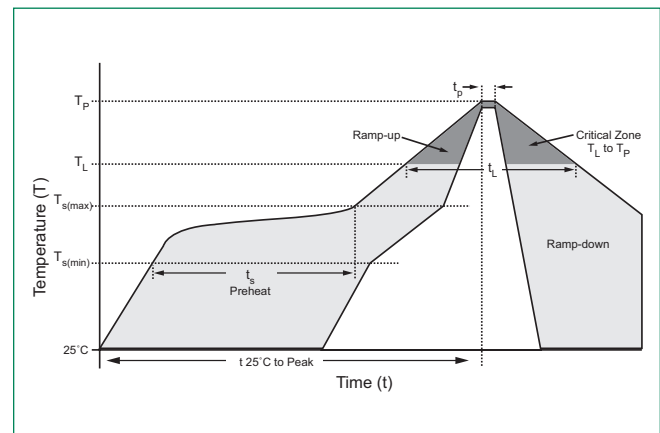


Figure 8 - Peak Forward Voltage Drop vs Peak Forward Current (Typical Values)



Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 120 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_p)		260 $^{+0/-5}$ °C
Time within 5°C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C



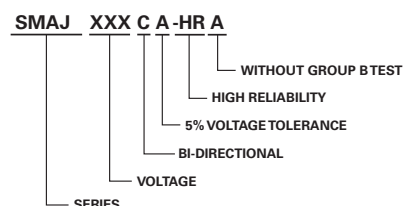
Physical Specifications

Weight	0.002 ounce, 0.061 gram
Case	JEDEC DO-214AC Molded Plastic over glass passivated junction
Polarity	Color band denotes cathode except bidirectional
Terminal	Matte Tin-plated leads. Solderable per JESD22-B102

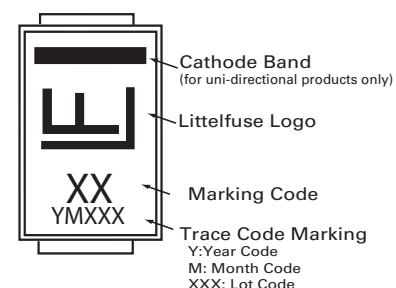
Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, Level 1
H3TRB	JESD22-A101
RSH	JESD22-A111

Part Numbering System



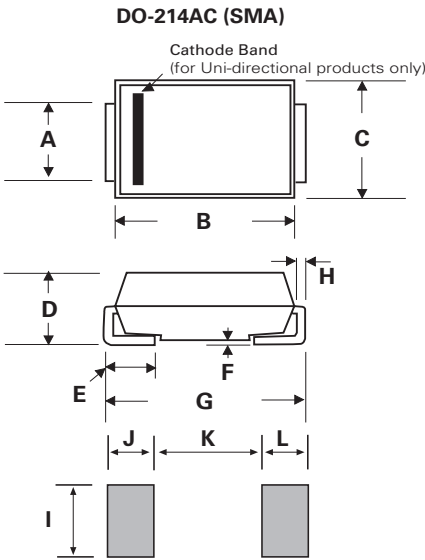
Part Marking System



SMAJ-HRA Series

Surface Mount - 400W

Dimensions



Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.049	0.065	1.250	1.650
B	0.157	0.181	3.990	4.600
C	0.095	0.110	2.400	2.790
D	0.075	0.090	1.900	2.290
E	0.030	0.060	0.780	1.520
F	-	0.008	-	0.203
G	0.189	0.208	4.800	5.280
H	0.006	0.012	0.152	0.305
I	0.070	-	1.800	-
J	0.082	-	2.100	-
K	-	0.090	-	2.300
L	0.082	-	2.100	-

Packaging

Part number	Component Package	Quantity	Packaging Option	Packaging Specification
SMAJ-xxxXX-HRA	DO-214AC	5000	Tape & Reel - 12mm tape/13" reel	EIA STD RS-481

Tape and Reel Specification

